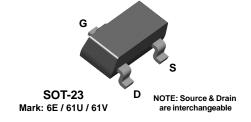


2N5460 2N5461 2N5462 MMBF5460 MMBF5461 MMBF5462





## P-Channel General Purpose Amplifier

This device is designed primarily for low level audio and general purpose applications with high impedance signal sources. Sourced from Process 89.

## Absolute Maximum Ratings\* TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units	
$V_{DG}$	Drain-Gate Voltage	- 40	V	
$V_{GS}$	Gate-Source Voltage	40	V	
I <sub>GF</sub>	Forward Gate Current	10	mA	
T <sub>J</sub> ,T <sub>stg</sub>	Operating and Storage Junction Temperature Range	-55 to +150	°C	

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

#### NOTES

1) These ratings are based on a maximum junction temperature of 150 degrees C.

## Thermal Characteristics TA = 25°C unless otherwise noted

Symbol	Characteristic	Max		Units
		2N5460-5462	*MMBF5460-5462	
$P_D$	Total Device Dissipation Derate above 25°C	350 2.8	225 1.8	mW mW/°C
R <sub>θJC</sub>	Thermal Resistance, Junction to Case	125		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	556	°C/W

<sup>\*</sup>Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06."

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2N5460/5461/5462/MMBF5460/5461/5462, Rev A

<sup>2)</sup> These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

# P-Channel General Purpose Amplifier (continued)

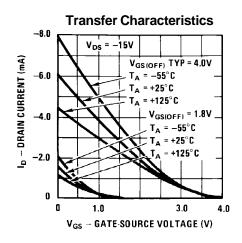
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
	RACTERISTICS					
V <sub>(BR)GSS</sub>	Gate-Source Breakdown Voltage	$I_G = 10 \mu\text{A},  V_{DS} = 0$	40			V
Igss	Gate Reverse Current	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0, T <sub>A</sub> = 100°C			5.0 1.0	nA μA
V <sub>GS(off)</sub>	Gate-Source Cutoff Voltage	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 1.0 μA	1.0		6.0 7.5 9.0	V V V
V <sub>G</sub> S	Gate-Source Voltage	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 0.1 mA	0.5		4.0 4.5 6.0	V
		5461 5462	_		- 9.0 - 16	mA mA
	ı	5462	2   - 4.0		- 16	mA
SMALL SI	GNAL CHARACTERISTICS					
<b>g</b> fs	Forward Transfer Conductance	$V_{DS} = 15 \text{ V}, V_{GS} = 0, f = 1.0 \text{ kHz}$ 5460			4000	
		5461 5462			5000 6000	μmhos μmhos μmhos
g <sub>os</sub>	Output Conductance					μmhos
•	Output Conductance Input Capacitance	5462		5.0	6000	μmhos μmhos
Ciss	'	5462 V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0, f = 1.0 kHz		5.0	6000 75	μmhos μmhos μmhos
gos Ciss Crss NF	Input Capacitance	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0, f = 1.0 kHz V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0, f = 1.0 MHz			6000 75 7.0	μmhos μmhos μmhos pF

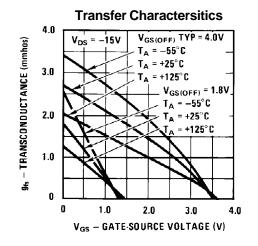
<sup>\*</sup>Pulse Test: Pulse Width  $\leq$  300 ms, Duty Cycle  $\leq$  2%

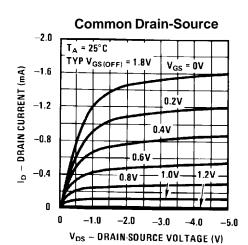
## P-Channel General Purpose Amplifier

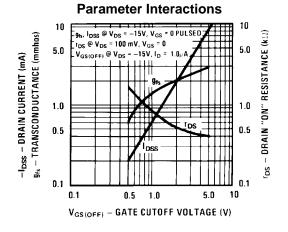
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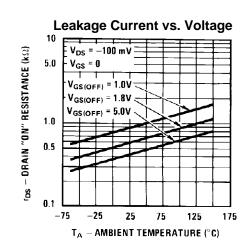
### Typical Characteristics (continued)

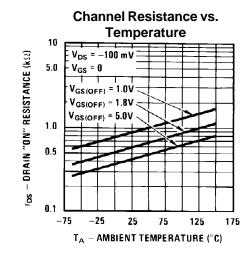








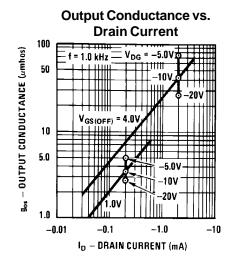


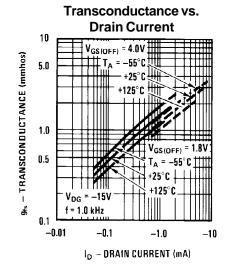


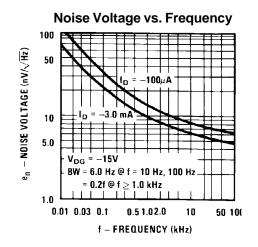
## **P-Channel General Purpose Amplifier**

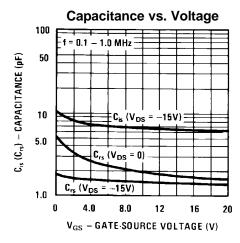
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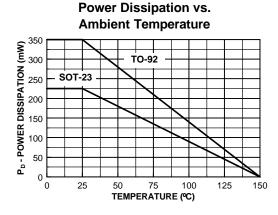
## Typical Characteristics (continued)











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